



# Diamond Pixel Modules

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for the RD42 Collaboration

**11th Pisa Meeting on Advanced Detectors**  
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## Outline of the Talk

- ❖ Introduction
- ❖ Radiation Hardness Studies with Trackers
- ❖ Pixel Module Studies
- ❖ Material and Manufacturing Developments
- ❖ Summary



# The RD42 Collaboration



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22 Institutes



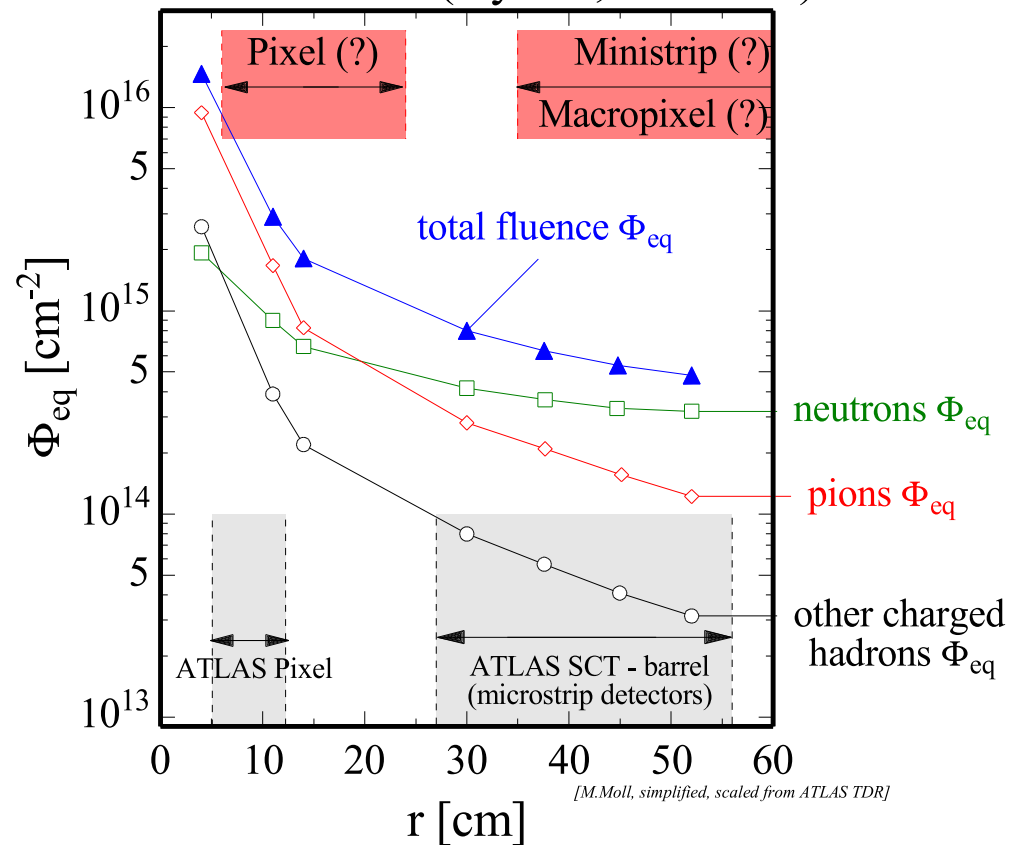
## Introduction



Motivation: Tracking Devices Close to Interaction Region of Experiments at the SLHC

Scale is  $\sim 10^{16} \text{ cm}^{-2} \rightarrow$  Annual replacement of inner layers perhaps?  $\rightarrow$  No

SUPER - LHC (5 years,  $2500 \text{ fb}^{-1}$ )





*Motivation: Tracking Devices Close to Interaction Region of Experiments*

*Look for a Material with Certain Properties:*

- ❖ Radiation hardness (no frequent replacements)
- ❖ Low dielectric constant → low capacitance
- ❖ Low leakage current → low readout noise
- ❖ Good insulating properties → large active area
- ❖ Room temperature operation, Fast signal collection time → no cooling

*Presented Here:*

- ❖ Radiation hardness tests of the highest quality pCVD and scCVD diamond
- ❖ Beam tests results to characterize quality
- ❖ Pixel Module preparation
- ❖ Manufacturing Developments
- ❖ See also talk by A. Gorišek - ATLAS Diamond BCM and BLM
  
- ❖ *Reference* → <http://rd42.web.cern.ch/RD42>
- ❖ *Diamonds supplied by/in collaboration with Diamond Detector Ltd./Element Six Ltd.*

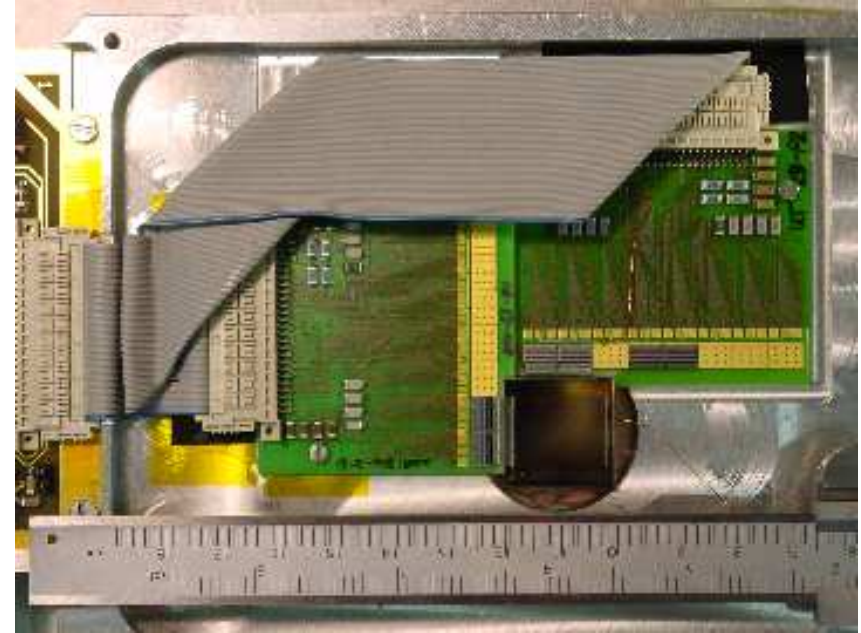
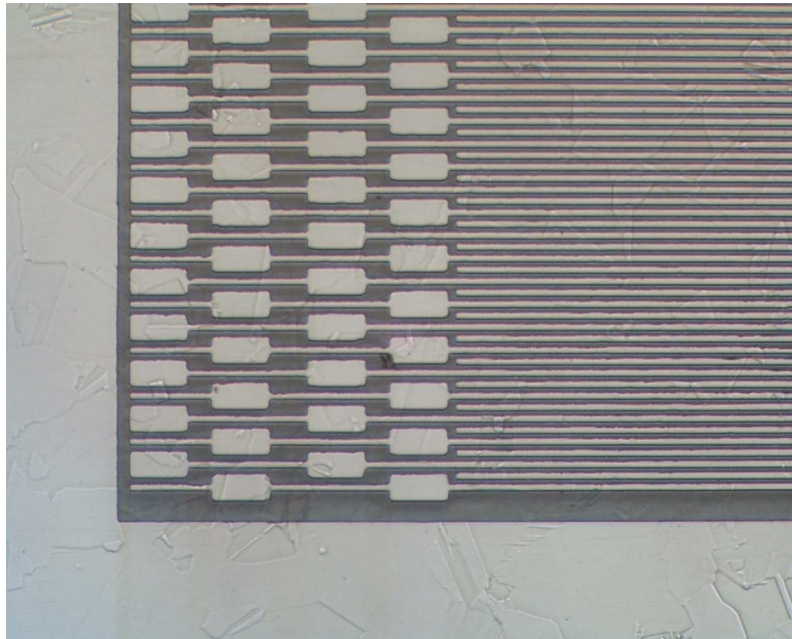


# Radiation Hardness

- binding energy
- displacement energy
- elastic, inelastic, total cross section



## pCVD Diamond Trackers:



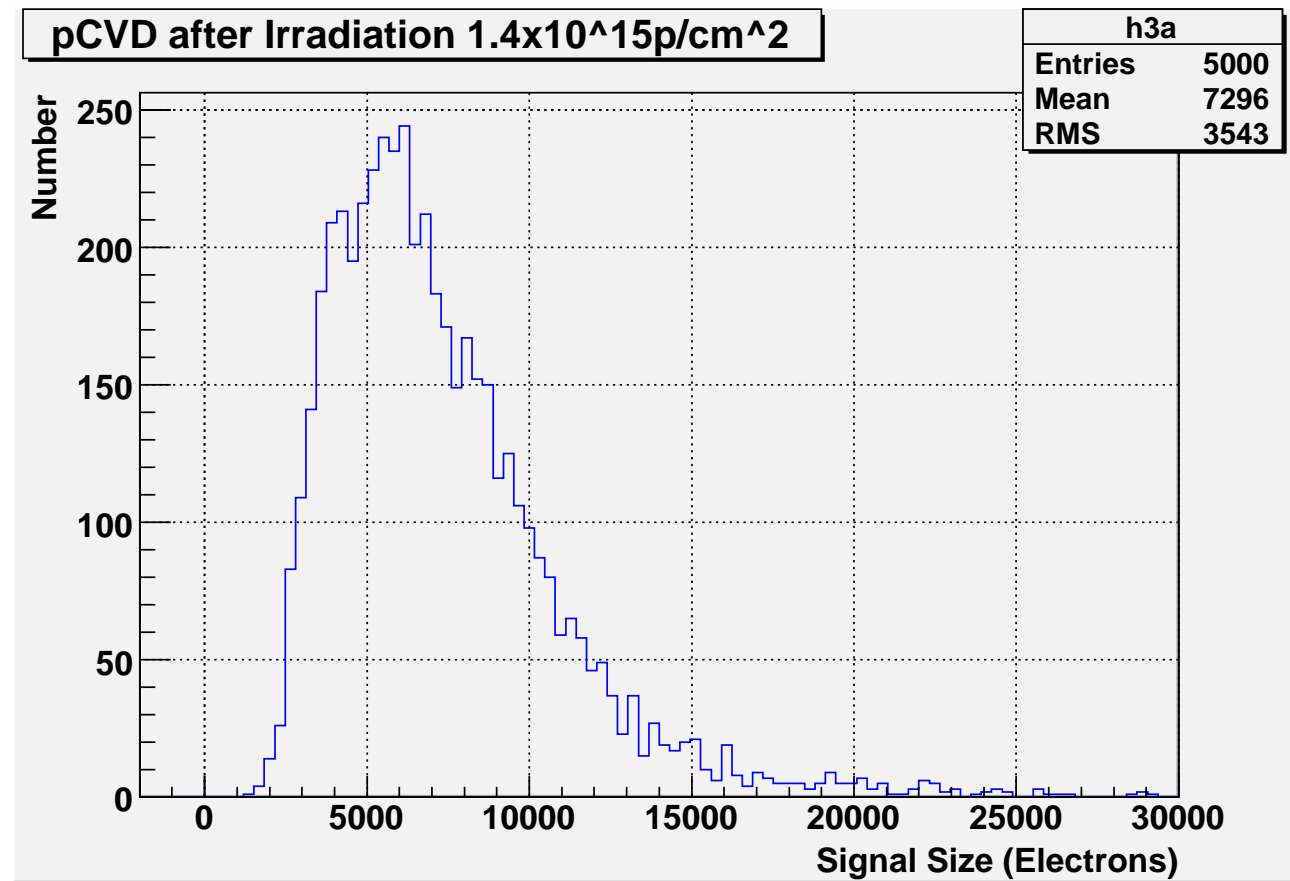
- ❖ Patterning the diamond → pads, strips, pixels!
- ❖ Successfully made double-sided devices; could be made edgeless.
- ❖ Use trackers (strip or pixel) in radiation studies - charge and position.



## pCVD Diamond After Irradiation



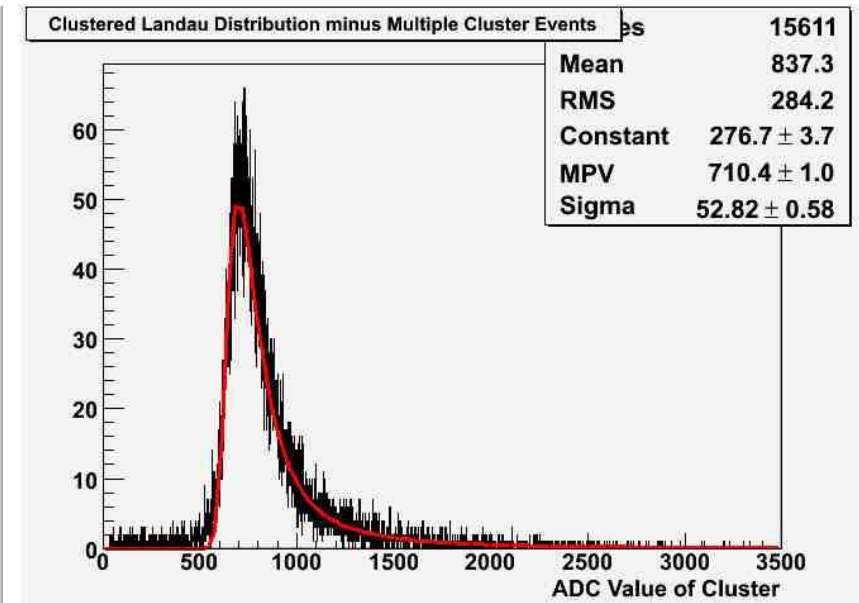
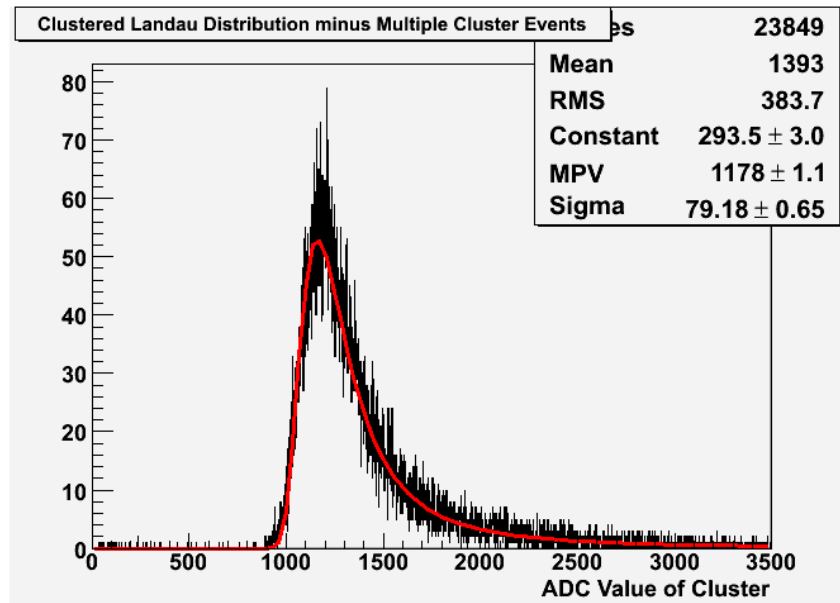
Polycrystalline CVD (pCVD) Diamond irradiations at  $1.4 \times 10^{15}$



- ❖ Application is pixel detectors
- ❖ At LHC (FE-I3), Thresholds are  $\sim$  noise(1400e) plus overdrive(800e)
- ❖ PH distributions look good after irradiation of  $1.4 \times 10^{15} \text{p/cm}^2$ .



## Single Crystal CVD (scCVD) Diamond irradiations at $1.5 \times 10^{15}$

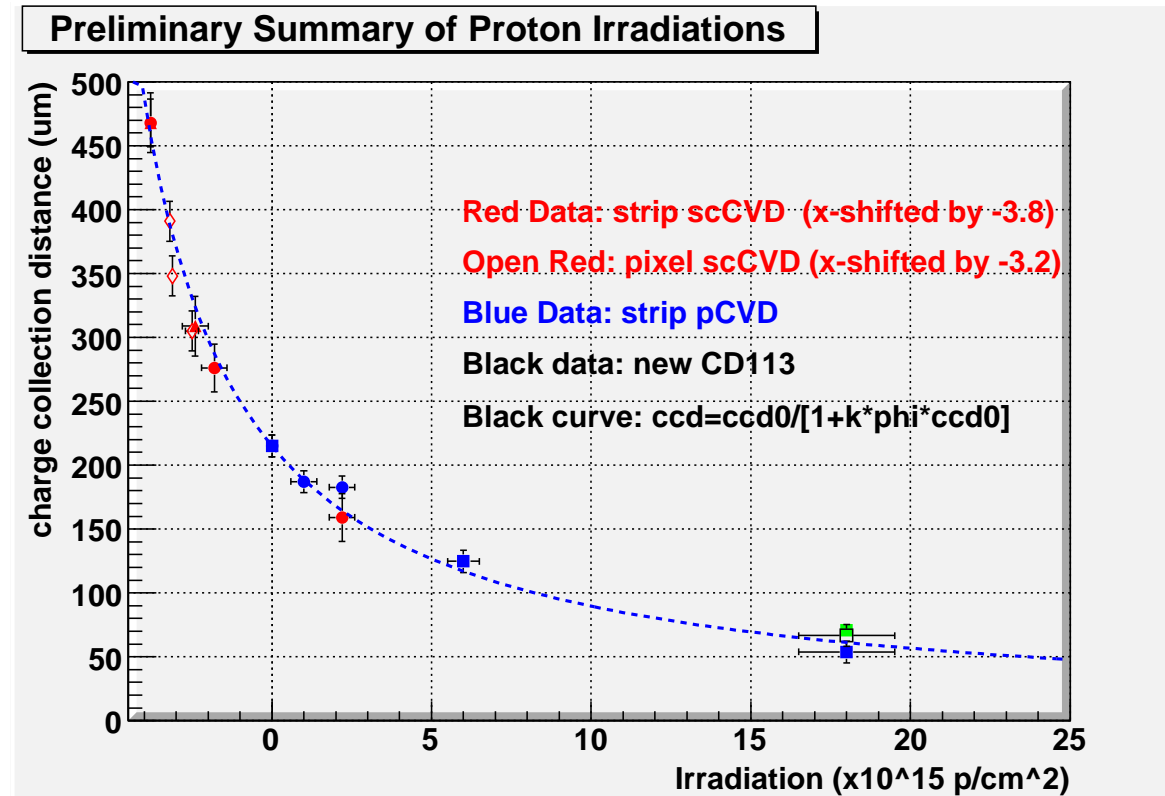


- ◆ PH distributions look narrow before and after irradiation
- ◆ PH distributions after  $1.5 \times 10^{15} \text{ p/cm}^2 \rightarrow \epsilon > 99\%$ .





## 24GeV Proton Irradiation Summary 2009:



New results from pixel modules - diamond and electronics irradiated!

Irradiation results up to  $1.8 \times 10^{16}$  p/cm<sup>2</sup> ( $\sim 500$ Mrad).

pCVD and scCVD diamond follow the same damage curve:

$$1/ccd = 1/ccd_0 + k \phi.$$



### Work in Progress 2009:

- ❖ Irradiations already performed awaiting test beam:

  - Sendai -  $1 \times 10^{16}$  70MeV protons/cm<sup>2</sup>

  - Ljubljana -  $1 \times 10^{16}$  neutrons/cm<sup>2</sup>

- ❖ Irradiations in progress:

  - Karlsruhe - 25MeV protons

In diamond 70MeV protons have  $\sim 3x$  larger damage constant than 24GeV



# pCVD and scCVD Pixel Detectors

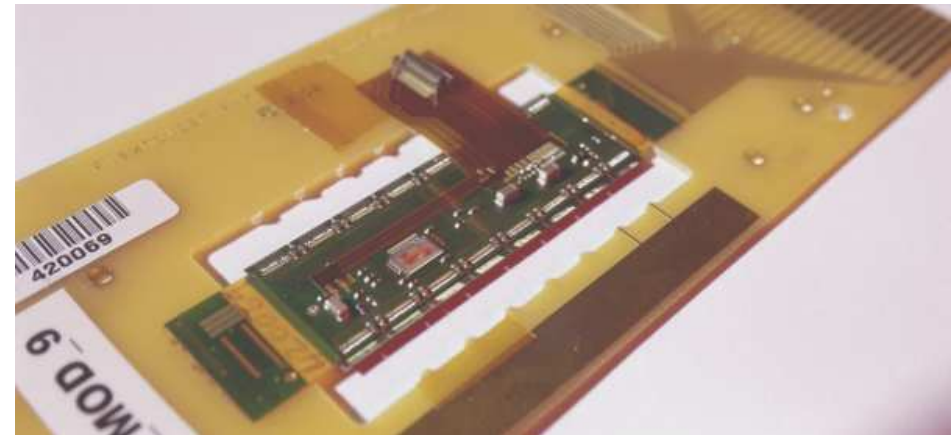
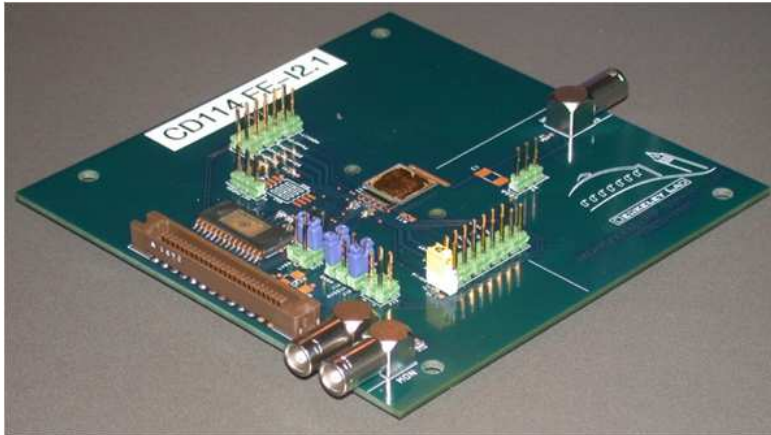
- signal
- noise, threshold, overdrive
- charge sharing, signal over threshold



## ATLAS Diamond Pixel Detectors



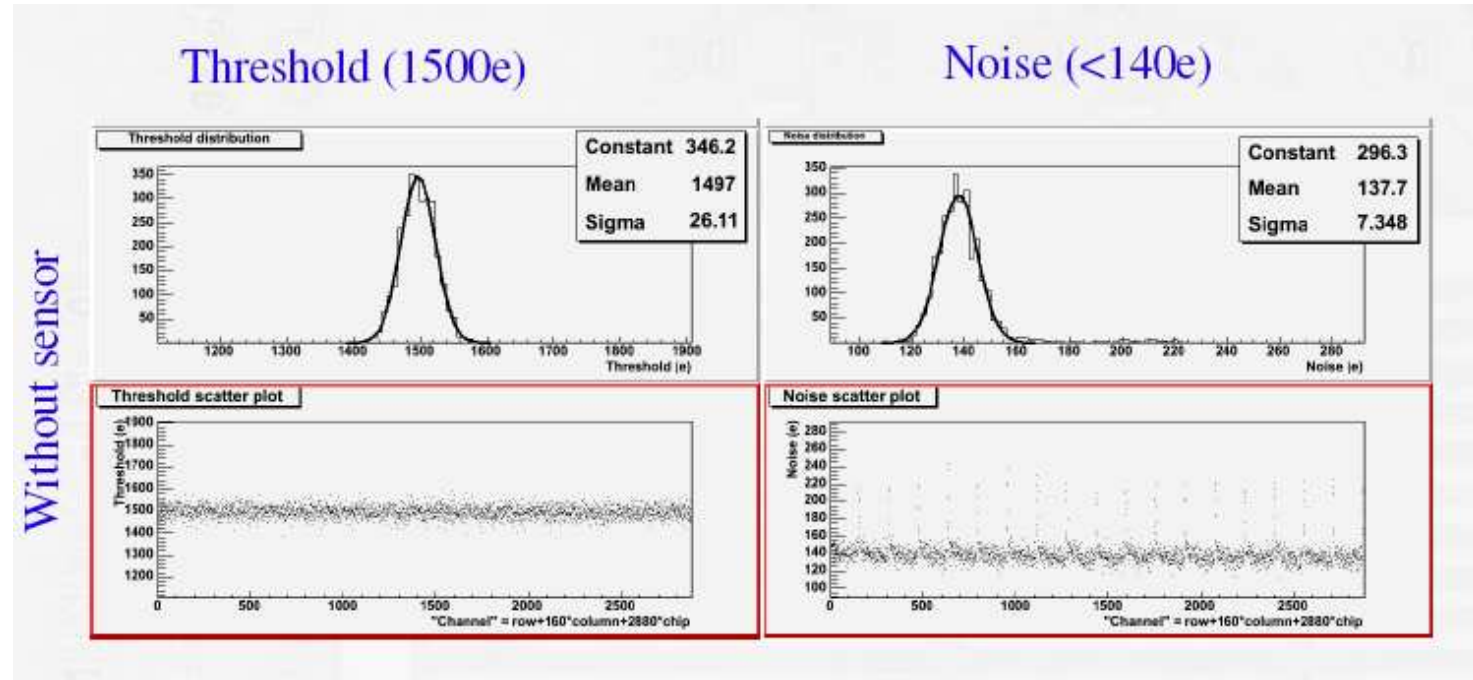
Recall: Full 16 Chip and 1 chip ATLAS diamond pixel modules



- ❖ Single chip and full modules bump-bonded at IZM (Berlin), constructed and tested in Bonn
- ❖ Operating parameters (FE-I3): Peaking Time 22ns, Noise 140 $e$ , Threshold 1450-1550 $e$ , Threshold Spread 25 $e$ , Overdrive 800 $e$



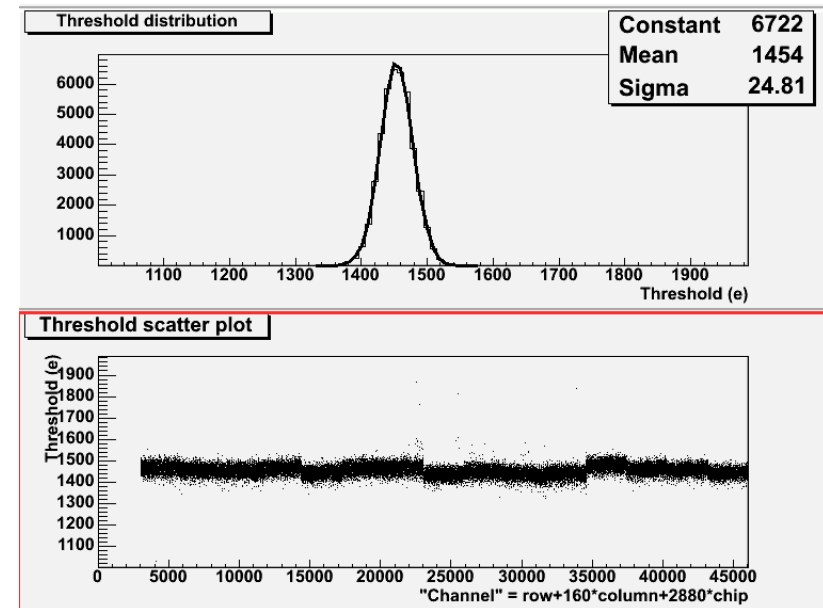
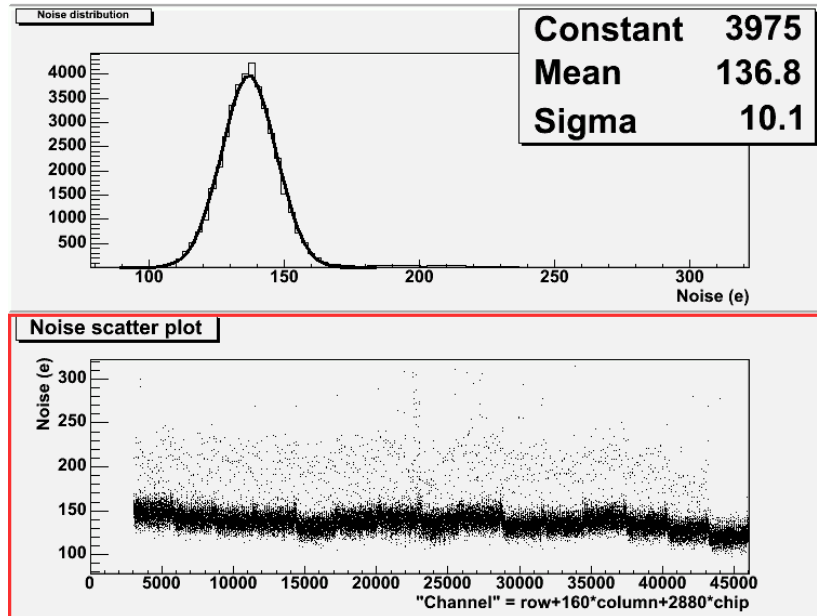
## The ATLAS pixel module - Bare Chip, No Detector - Noise, Threshold



Results: Bare Noise  $\sim 140e$ , Bare Mean Threshold  $\sim 1500e$ ,  
Bare Threshold Spread  $\sim 25e$ .



## The full ATLAS diamond pixel module - Noise, Threshold

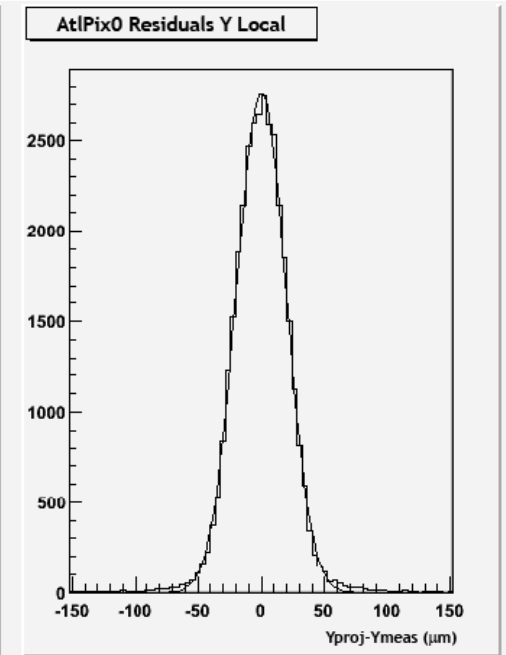
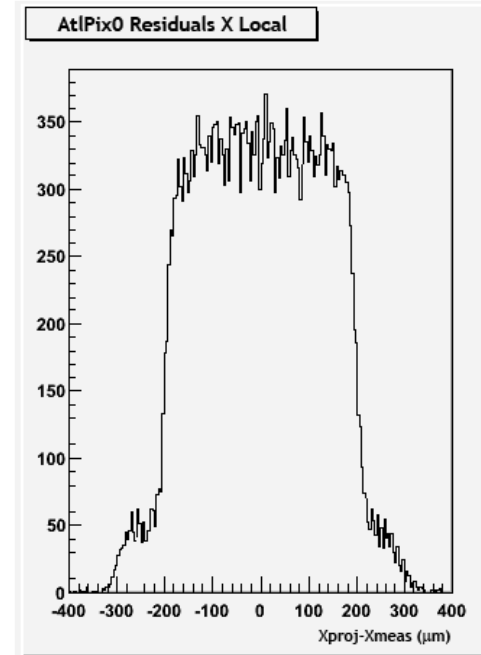
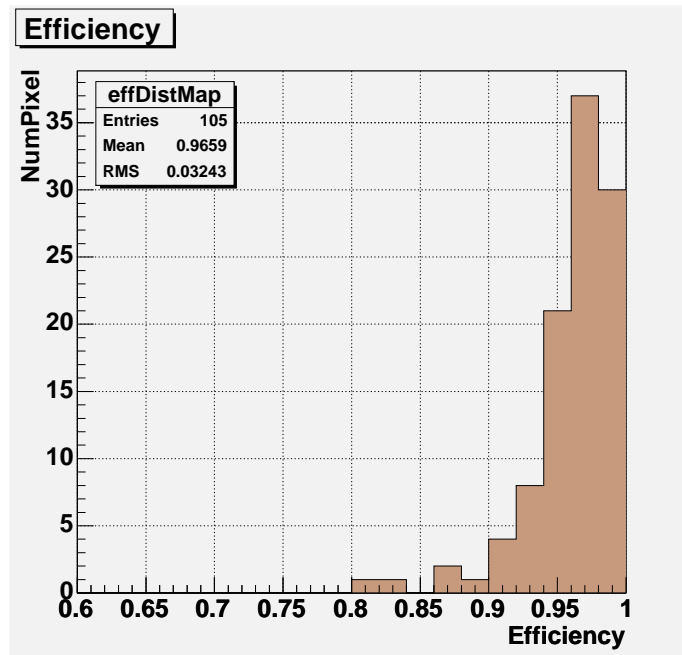


Results: Noise  $\sim 137e$ , Mean Threshold  $1454e$ , Threshold Spread  $\sim 25e$ .  
Noise, threshold, threshold spread do not change from bare chip.

→ Advantage of low capacitance, no leakage current



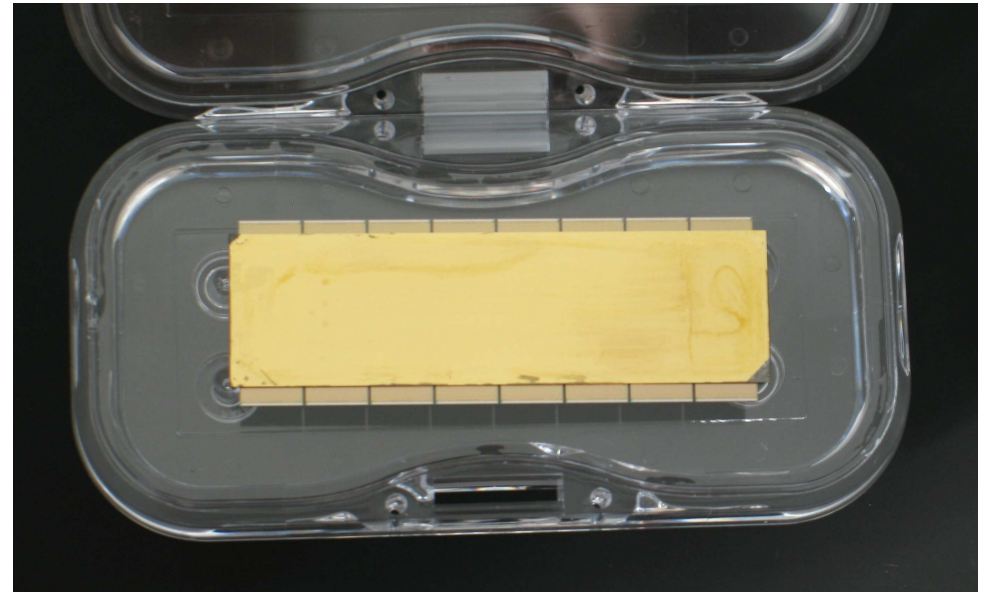
## Recall: Full ATLAS diamond pixel module - Efficiency, Resolution



- ◆ Excellent correlation with telescope, efficiency  $> 97\%$
- ◆ Residual  $\sim 18\mu\text{m}$  - remove telescope tracking contribution  $\rightarrow 14\mu\text{m}$ .



## New: First Full Diamond Pixel Module Made in Industry



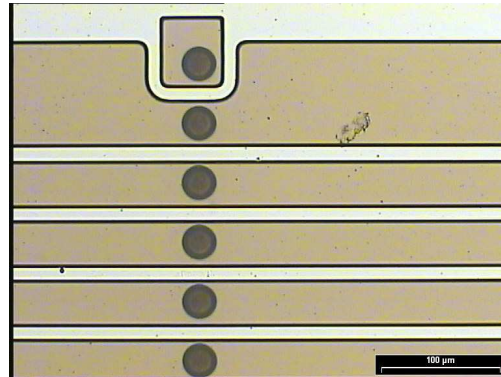
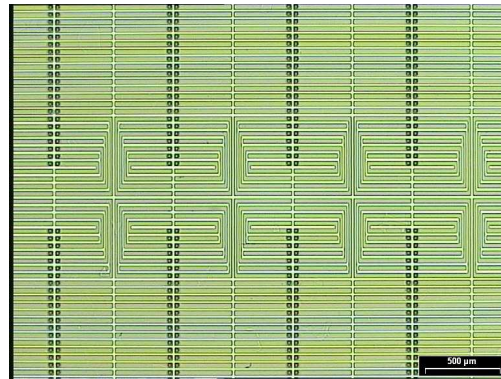
- ◆ Begin with a tested raw diamond
- ◆ Clean → IZM in Berlin
- ◆ Receive finished, metalised, bump-bonded module!



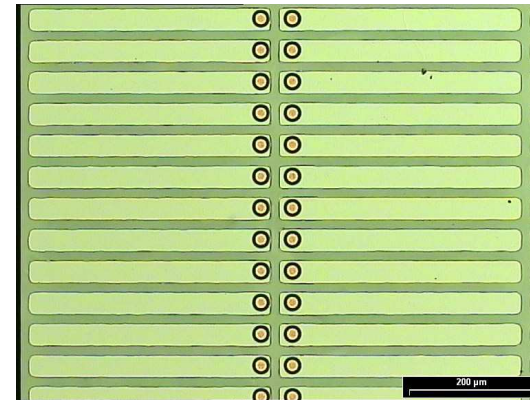
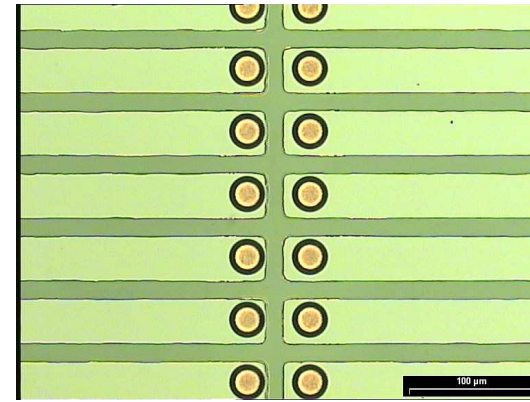


## New: First Full Diamond Pixel Module Made in Industry

### Diamond sensor pixel metallisation



Status after electroplating of pad metallisation and lithography for pixel metallisation patterning



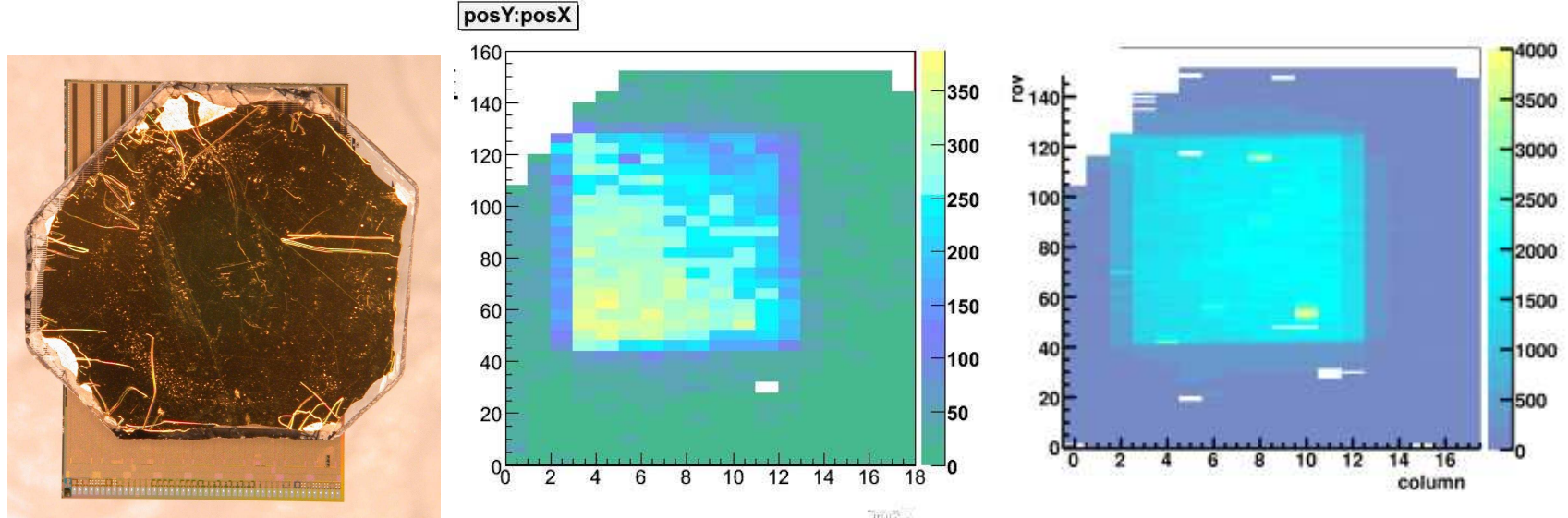
result after pixel metallisation patterning



Fraunhofer  
Institut  
Zuverlässigkeit und  
Mikrointegration



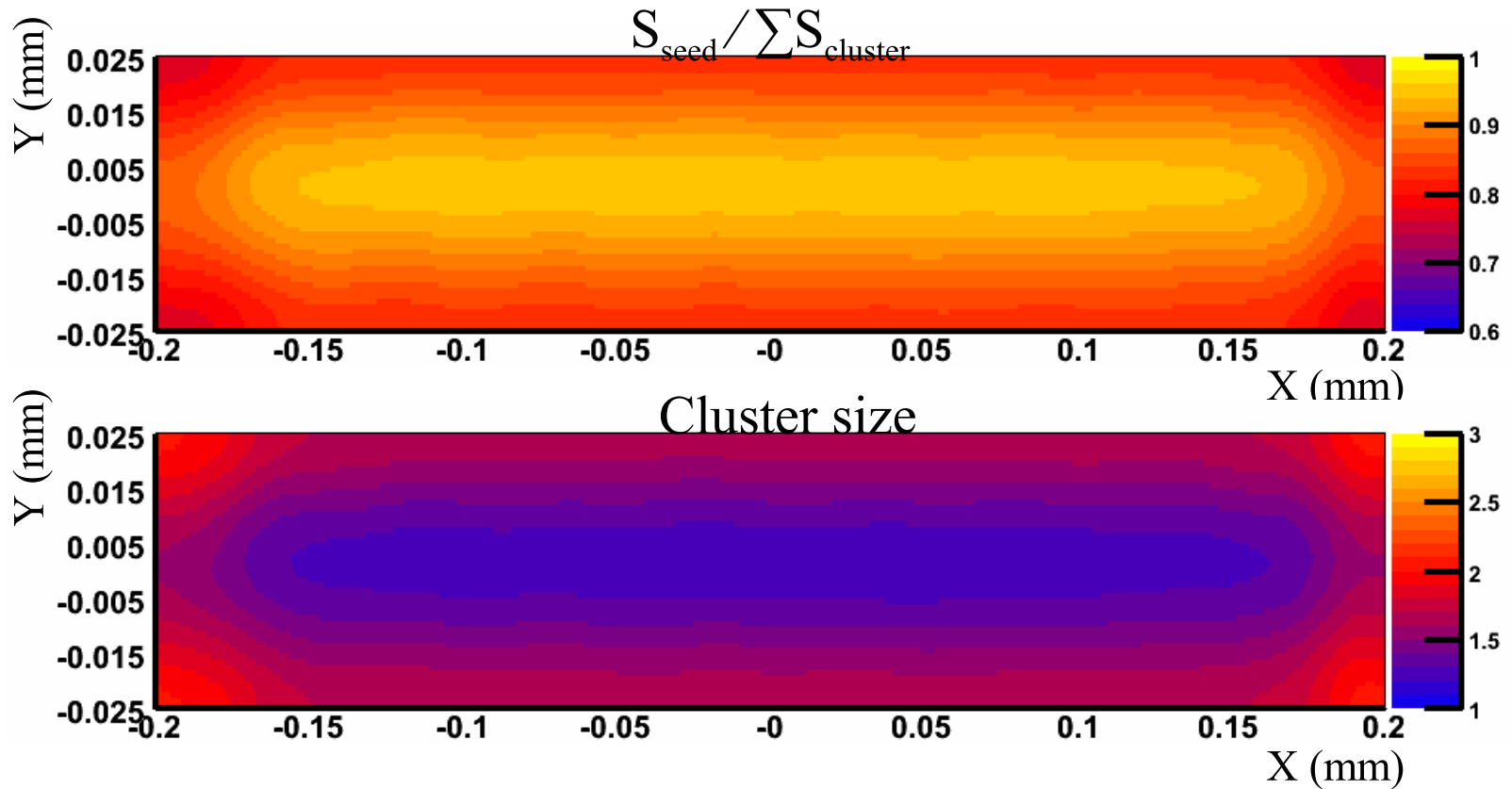
## The First scCVD ATLAS diamond pixel detector



- ◆ The hitmap plotted for all scintillation triggers with trigger in telescope.
- ◆ The raw hitmap looks goods -  $\sim 1$  dead pixel



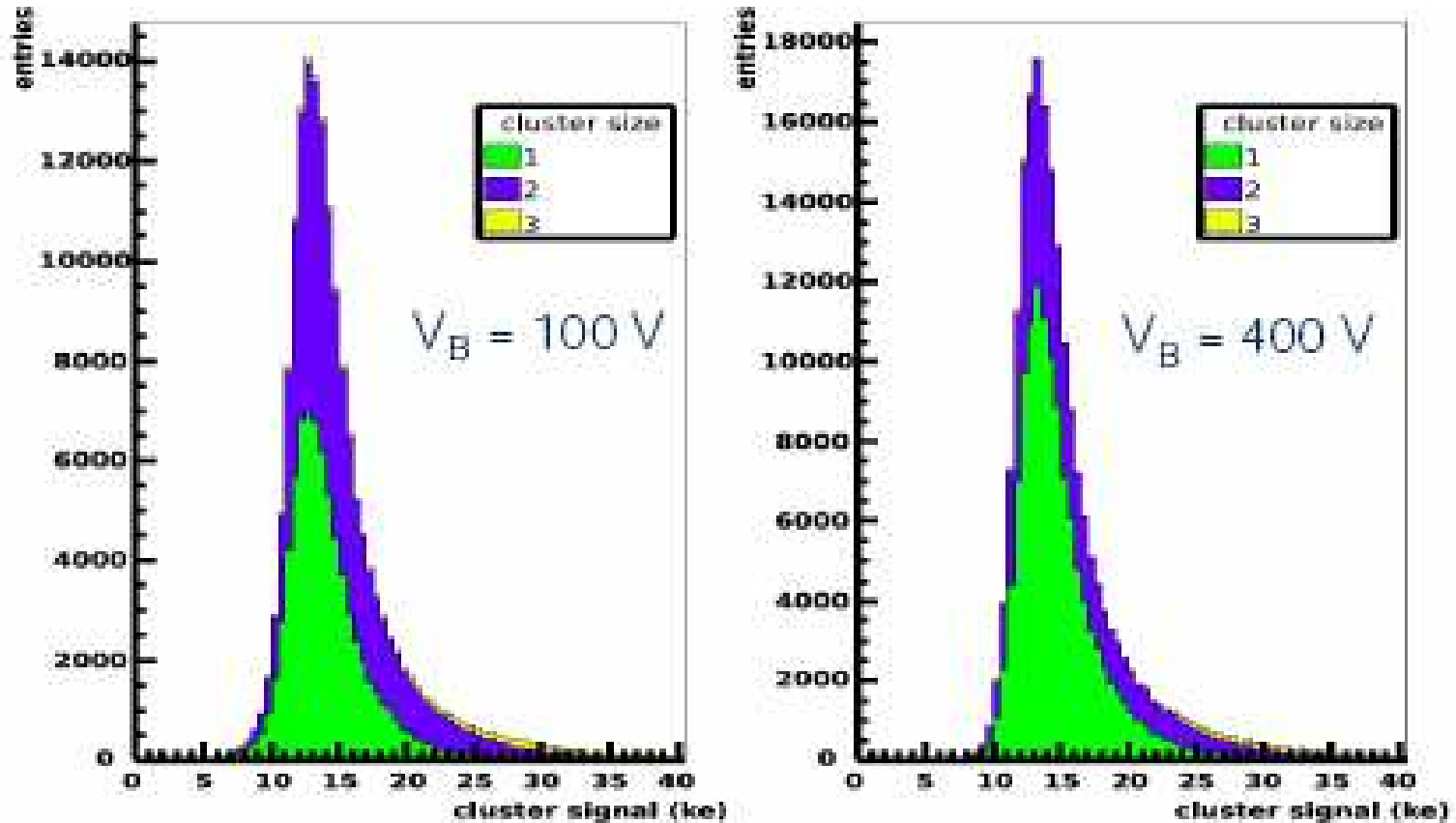
Last Year: The First scCVD ATLAS diamond pixel detector - Charge Sharing



◆ Charge sharing as expected



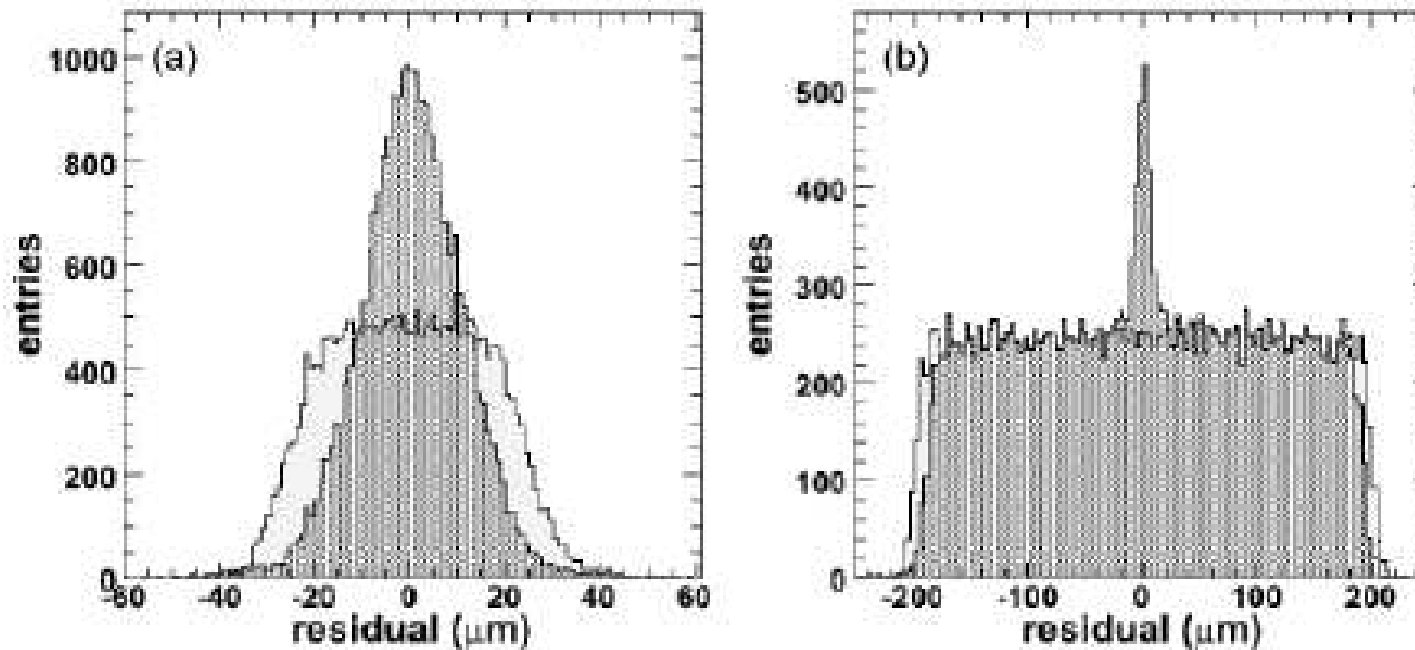
New This Year: Cluster Signal



- ◆ As voltage is raised  $\rightarrow$  more 1-hit clusters
- ◆ Larger drift speed  $\rightarrow$  less lateral diffusion
- ◆ Cluster signal as expected



## New This Year: Spatial Resolution (1-pixel and 2-pixel $\eta$ )



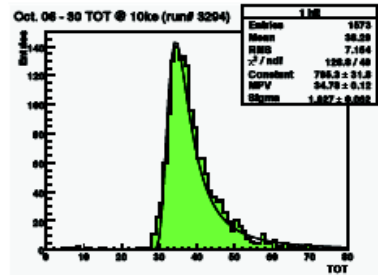
- ◆ Plot contains all scintillator triggers with “track” trigger in telescope
- ◆ Diamond pixel resolution  $8.9\mu\text{m}$  for normal incidence
- ◆ Lower threshold  $\rightarrow$  more charge sharing observed  $\rightarrow$  better spatial resolution.



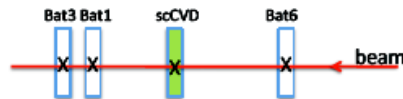
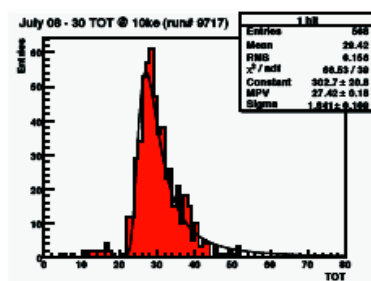
## New This Year: Irradiated scCVD Diamond Pixel Module

### TOT comparison (Oct.06 – Jul08)

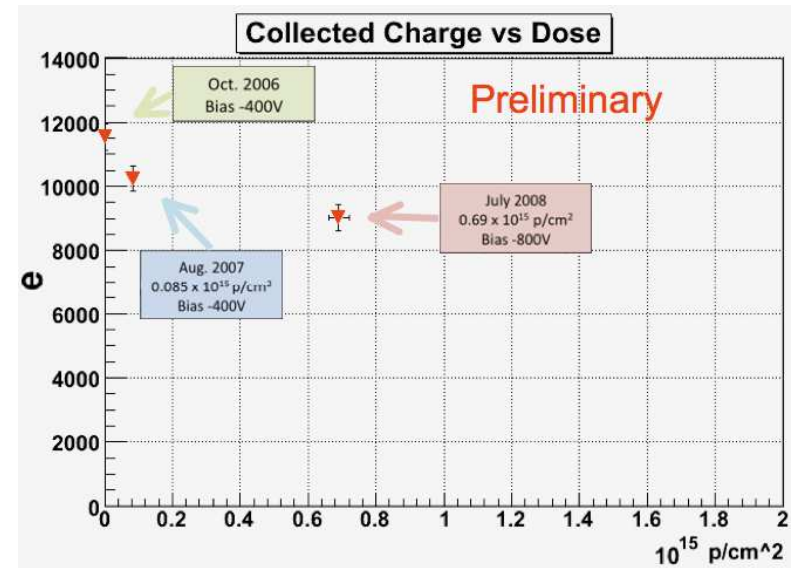
BEFORE irradiation



AFTER irradiation ( $f_T = 0.7 \times 10^{15} \text{ p/cm}^2$ )



Only data from events with a single hit in each of the telescope planes are selected.



- ◆ Full module irradiated - electronics and diamond.
- ◆ Data falls on expected damage curve!




## Next Steps



On the basis of these results ATLAS officially approved Upgrade R&D on Diamond Pixel Detectors

### Proposing Institutes:

- ❖ Carleton University (Canada)
- ❖ University of Toronto (Canada)
- ❖ University of Bonn (Germany)
- ❖ Jožef Stefan Institute (Slovenia)
- ❖ CERN
- ❖ Ohio State University (US)
  
- ❖ Submitted May 2007
- ❖ Approved Feb 2008
- ❖ Technical Decision 2010

	Diamond Pixel Modules for the High Luminosity		
	ATLAS Inner Detector Upgrade		
ATLAS Upgrade Document No.	Institute Document No.	Created: 15/05/2007	Page: 1 of 14
		Modified: 21/12/2007	Rev. No.: 1.8

#### Abstract

*The goal of this proposal is to construct diamond pixel modules as an option for the ATLAS pixel detector upgrade. This proposal is made possible by progress in three areas: the recent reproducible production of high quality polycrystalline Chemical Vapour Deposition diamond material in wafers, the successful completion and test of the first diamond ATLAS pixel module, and the operation of a diamond after irradiation to  $1.8 \times 10^{16}$  p/cm<sup>2</sup>. In this proposal we outline the results in these three areas and propose a plan to build 5 to 10 ATLAS diamond pixel modules, characterize their properties, test their radiation hardness, explore the cooling advantages made available by the high thermal conductivity of diamond and demonstrate industrial viability of bump-bonding of diamond pixel modules. Based on availability and size polycrystalline Chemical Vapour Deposition diamond has been chosen as the baseline solution. The use of single crystal Chemical Vapour Deposition diamond is reserved as a future option if the manufacturers can attain sizes in the range 16mm x 16mm.*

Reference → ATU-RD-MN-0012, EDMS ID: 903424



## Next Steps Checklist



- ❖ **Re-Test ATLAS Pixel Module at CERN - Done**  
Data analysis → Thesis
- ❖ **Irradiate scCVD and pCVD diamonds - Done**  
pCVD to  $2 \times 10^{16}$  and scCVD to  $2 \times 10^{15}$  p/cm<sup>2</sup>
- ❖ **Irradiate scCVD pixel modules (chip and detector) - Done**  
Up to  $\sim 10^{15}$
- ❖ **Move Metalization to Industry - Done**  
Cleaner facilities  
Metalization and bumping done at one facility  
This should be easy ... IZM is interested
- ❖ **Produce 5-10 Modules - ongoing**  
Evaluate production process  
Full measure of efficiency, noise, etc.
- ❖ **Test of Modules - beginning**  
Beam test of production modules  
Radiation hardness test of production modules

→ Progress on many fronts!!!





# CVD Diamond Material Status

- collection distance
- polycrystalline, single crystal
- new manufacturers

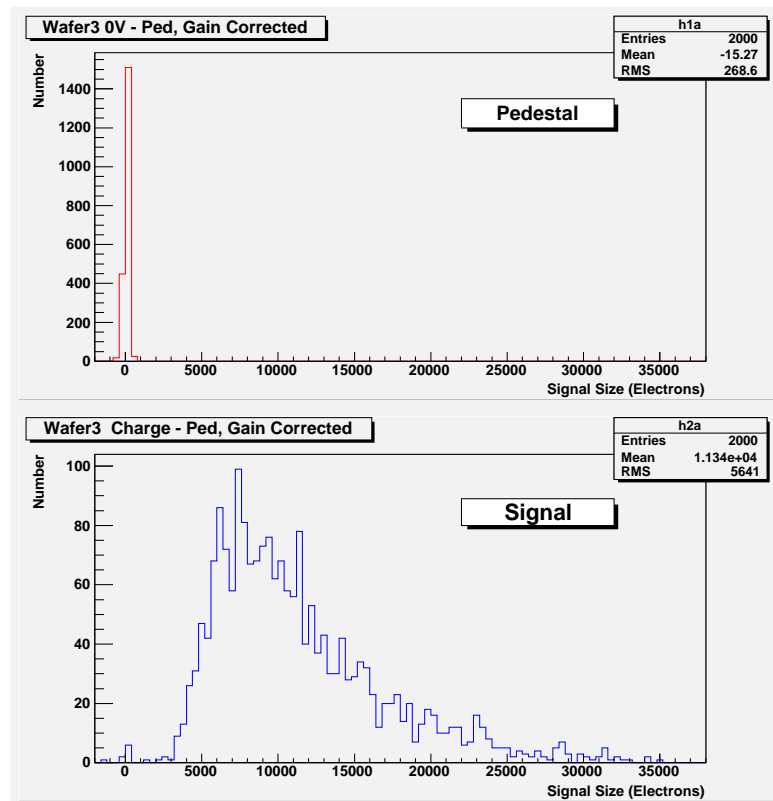


## Material Status - Polycrystalline CVD Diamond



*pCVD Material: pCVD Diamond Measured with a  $^{90}\text{Sr}$  Source*

- ◆ Contacts on both sides - structures from  $\mu\text{m}$  to  $\text{cm}$
- ◆ Usually operate at  $E=1\text{-}2\text{V}/\mu\text{m}$
- ◆ Test Procedure: dot  $\rightarrow$  strip  $\rightarrow$  pixel on same diamond!

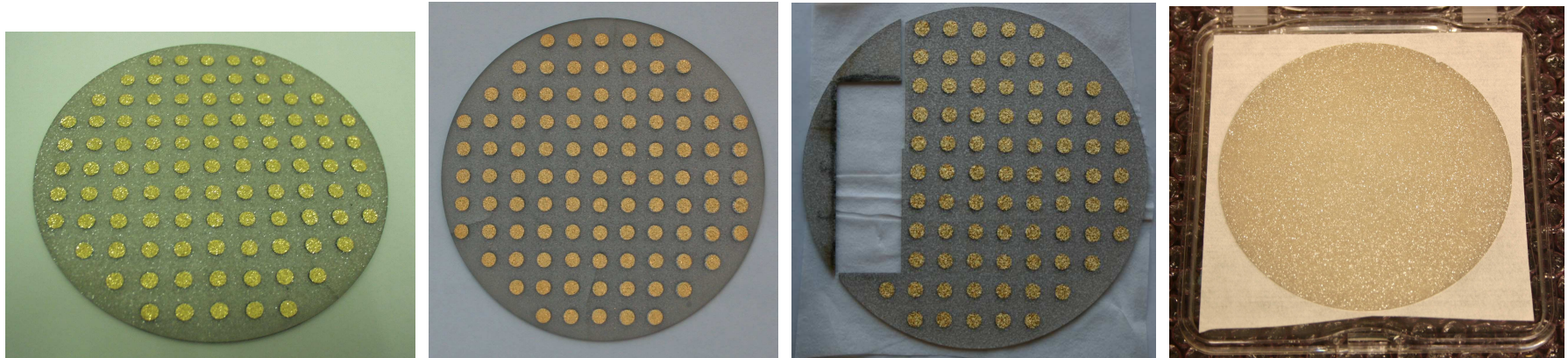


- ◆  $Q_{MP} = 8500\text{-}9000e$
- ◆ Mean Charge =  $11300e$

- ◆ Source data well separated from 0
- ◆ Collection Distance now  $\approx 300\mu\text{m}$
- ◆ Most Probable Charge now  $\approx 9000e$
- ◆ 99% of PH distribution above  $4000e$
- ◆  $\text{FWHM}/\text{MP} \approx 0.95$  — Si has  $\approx 0.5$
- ◆ Six wafers grown with this quality



### Recent Polycrystalline CVD Diamond

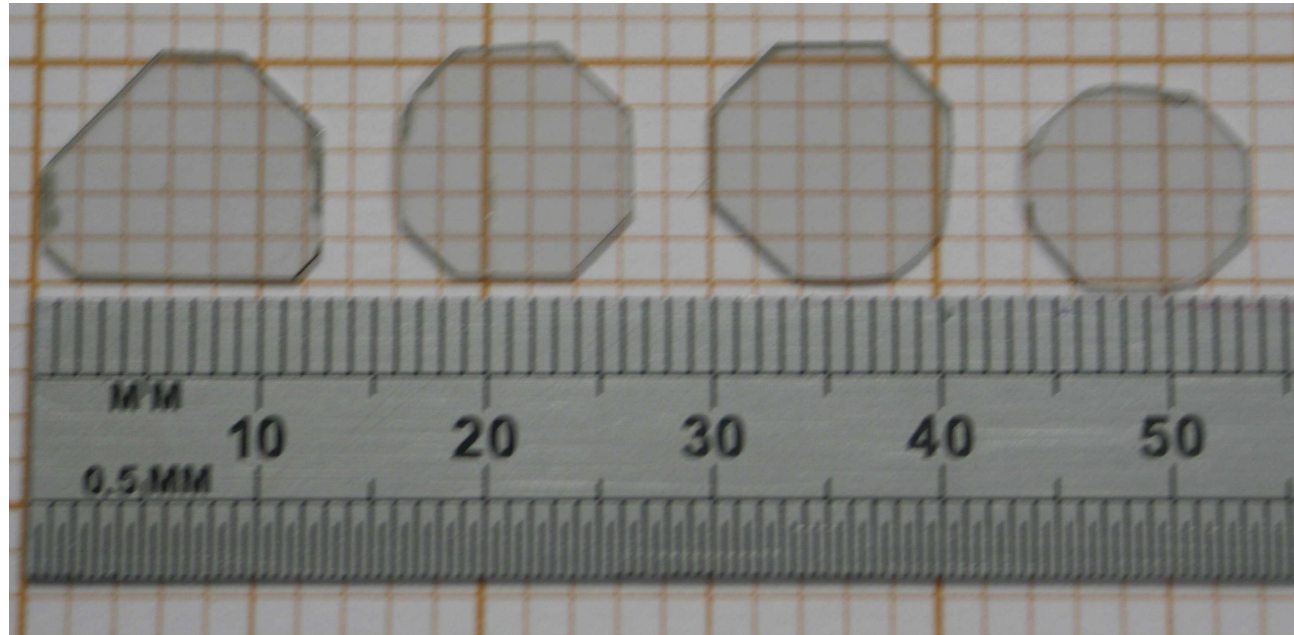


Recent pCVD wafers ready for test - Cr/Au dots are 1 cm apart

- ❖ New wafers continually being produced.
- ❖ Wafer collection distance now typically  $250\mu\text{m}$  (edge) to  $310\mu\text{m}$  (center).
- ❖ Contract for material with ccd  $> 275\mu\text{m} \rightarrow 300\mu\text{m}$ .
- ❖ Samples available by contacting DDL



### Recent Single Crystal CVD (scCVD) Diamond



RD42 continues to develop and test this material.

scCVD diamond can be grown  $\approx 10 \text{ mm} \times 10 \text{ mm}$ ,  $>1 \text{ mm}$  thickness.

Largest scCVD diamond grown  $\approx 14 \text{ mm} \times 14 \text{ mm}$ .

First results from irradiated scCVD pixel module.

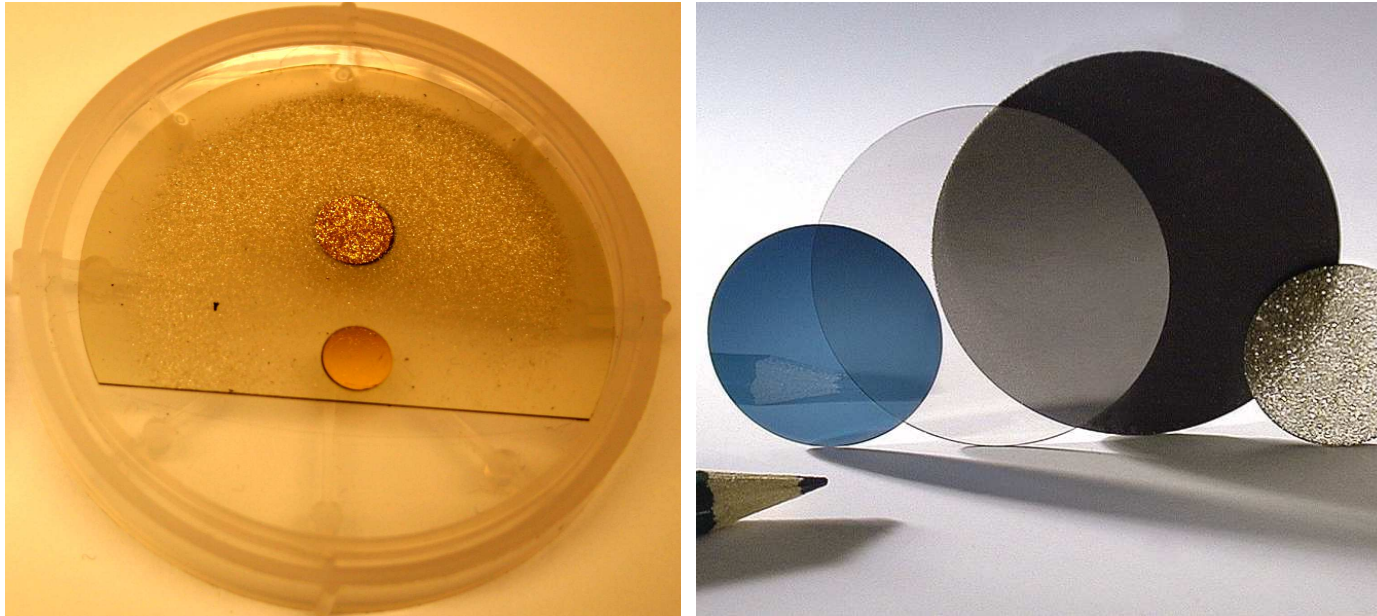


## Material Status: Additional Manufacturers



### Status:

RD42 has begun working with two companies (Germany, US) to develop detector grade diamond material



- ◆ First samples from companies show charge collection distance  $\sim 100\mu\text{m}$
- ◆ RD42 is working with these manufacturers on both pCVD and scCVD



### ❖ **Radiation Hardness of Diamond Trackers**

Using trackers allows a correlation between S/N and Resolution

With Protons:

- Dark current decreases with fluence
- pCVD and scCVD have same damage curve

### ❖ **Diamond Pixel Detectors**

Successfully tested a complete ATLAS pCVD module and scCVD module

Five full pCVD modules in production

Diamond R&D Approved by ATLAS for LHC Upgrade

### ❖ **Further Progress in Charge Collection**

pCVD - 320  $\mu\text{m}$  collection distance diamond attained in wafer growth

pCVD - 275-325  $\mu\text{m}$  collection distance for modules

scCVD - Full charge collection, fast, large signals, Getting larger?

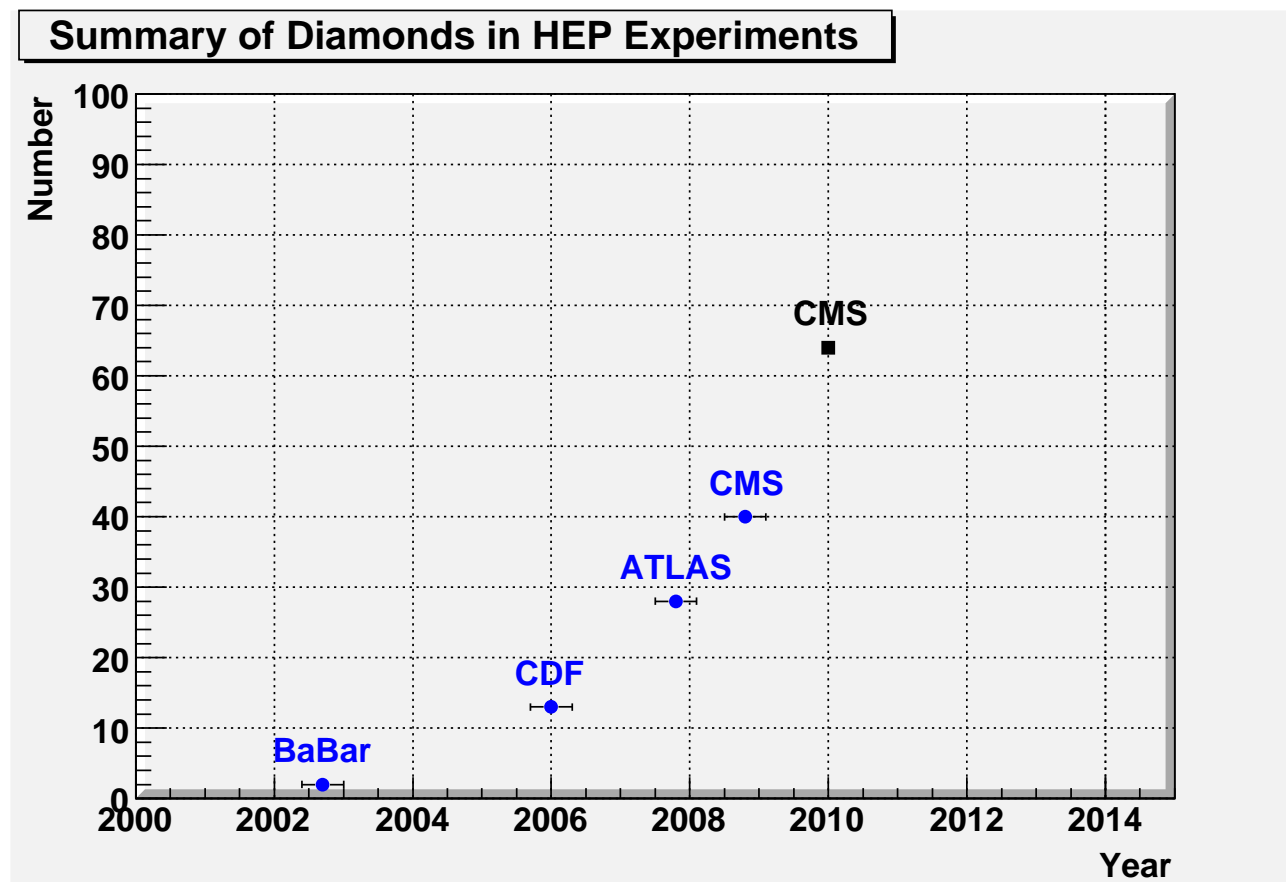
### ❖ **Beam Conditions Monitoring**

see A. Gorišek Talk on ATLAS diamond BCM and BLM

Application of diamond successful in BaBar, CDF, Alice, ATLAS, CMS, LHCb.



## CVD Diamond Used in High Energy Physics Experiments



Blue data installed; black data planned.  
Diamond use is on the rise!